

# SN54LVTH16500, SN74LVTH16500 3.3-V ABT 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

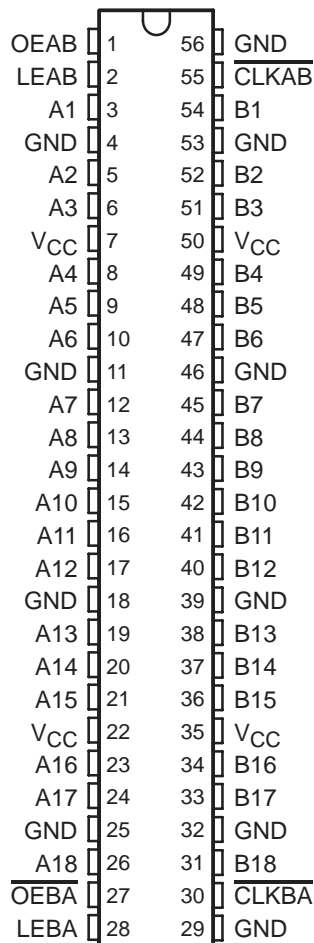
SCBS701F – JULY 1997 – REVISED SEPTEMBER 2003

- Members of the Texas Instruments Widebus™ Family
- UBT™ Transceivers Combine D-Type Latches and D-Type Flip-Flops for Operation in Transparent, Latched, or Clocked Mode
- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V V<sub>CC</sub>)
- Support Unregulated Battery Operation Down to 2.7 V
- Typical V<sub>OLP</sub> (Output Ground Bounce) <0.8 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- I<sub>off</sub> and Power-Up 3-State Support Hot Insertion
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Distributed V<sub>CC</sub> and GND Pins Minimize High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

## description/ordering information

The 'LVTH16500 devices are 18-bit universal bus transceivers designed for low-voltage (3.3-V) V<sub>CC</sub> operation, but with the capability to provide a TTL interface to a 5-V system environment.

SN54LVTH16500 . . . WD PACKAGE  
SN74LVTH16500 . . . DGG OR DL PACKAGE  
(TOP VIEW)



## ORDERING INFORMATION

| T <sub>A</sub>        | PACKAGE†          |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|-----------------------|-------------------|---------------|-----------------------|------------------|
| –40°C to 85°C         | SSOP – DL         | Tube          | SN74LVTH16500DL       | LVTH16500        |
|                       |                   | Tape and reel | SN74LVTH16500DLR      |                  |
|                       | TSSOP – DGG       | Tape and reel | SN74LVTH16500DGGR     | LVTH16500        |
|                       | VFBGA – GQL       | Tape and reel | SN74LVTH16500GQLR     | LL500            |
| VFBGA – ZQL (Pb-free) | SN74LVTH16500ZQLR |               |                       |                  |
| –55°C to 125°C        | CFP – WD          | Tube          | SNJ54LVTH16500WD      | SNJ54LVTH16500WD |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus and UBT are trademarks of Texas Instruments.

UNLESS OTHERWISE NOTED this document contains PRODUCTION DATA information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 2003, Texas Instruments Incorporated

# SN54LVTH16500, SN74LVTH16500

## 3.3-V ABT 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS701F – JULY 1997 – REVISED SEPTEMBER 2003

### description/ordering information (continued)

Data flow in each direction is controlled by output-enable ( $\overline{OEAB}$  and  $\overline{OEBA}$ ), latch-enable (LEAB and LEBA), and clock ( $\overline{CLKAB}$  and  $\overline{CLKBA}$ ) inputs. For A-to-B data flow, the devices operate in the transparent mode when LEAB is high. When LEAB is low, the A data is latched if  $\overline{CLKAB}$  is held at a high or low logic level. If LEAB is low, the A data is stored in the latch/flip-flop on the high-to-low transition of  $\overline{CLKAB}$ . OEAB is active high. When OEAB is high, the B-port outputs are active. When OEAB is low, the B-port outputs are in the high-impedance state.

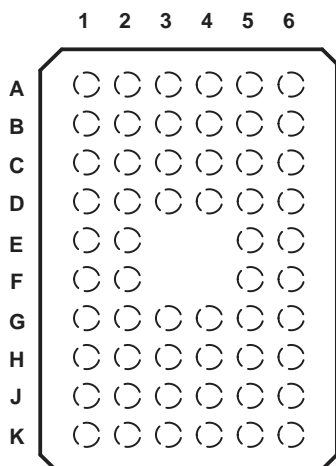
Data flow for B to A is similar to that of A to B, but uses  $\overline{OEBA}$ , LEBA, and  $\overline{CLKBA}$ . The output enables are complementary (OEAB is active high and  $\overline{OEBA}$  is active low).

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

When  $V_{CC}$  is between 0 and 1.5 V, the devices are in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor and OE should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sinking/current-sourcing capability of the driver.

These devices are fully specified for hot-insertion applications using  $I_{off}$  and power-up 3-state. The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

### GQL OR ZQL PACKAGE (TOP VIEW)



### terminal assignments

|   | 1   | 2                 | 3        | 4        | 5                  | 6   |
|---|-----|-------------------|----------|----------|--------------------|-----|
| A | A1  | LEAB              | OEAB     | GND      | $\overline{CLKAB}$ | B1  |
| B | A3  | A2                | GND      | GND      | B2                 | B3  |
| C | A5  | A4                | $V_{CC}$ | $V_{CC}$ | B4                 | B5  |
| D | A7  | A6                | GND      | GND      | B6                 | B7  |
| E | A9  | A8                |          |          | B8                 | B9  |
| F | A10 | A11               |          |          | B11                | B10 |
| G | A12 | A13               | GND      | GND      | B13                | B12 |
| H | A14 | A15               | $V_{CC}$ | $V_{CC}$ | B15                | B14 |
| J | A16 | A17               | GND      | GND      | B17                | B16 |
| K | A18 | $\overline{OEBA}$ | LEBA     | GND      | $\overline{CLKBA}$ | B18 |

# SN54LVTH16500, SN74LVTH16500 3.3-V ABT 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS701F – JULY 1997 – REVISED SEPTEMBER 2003

FUNCTION TABLE†

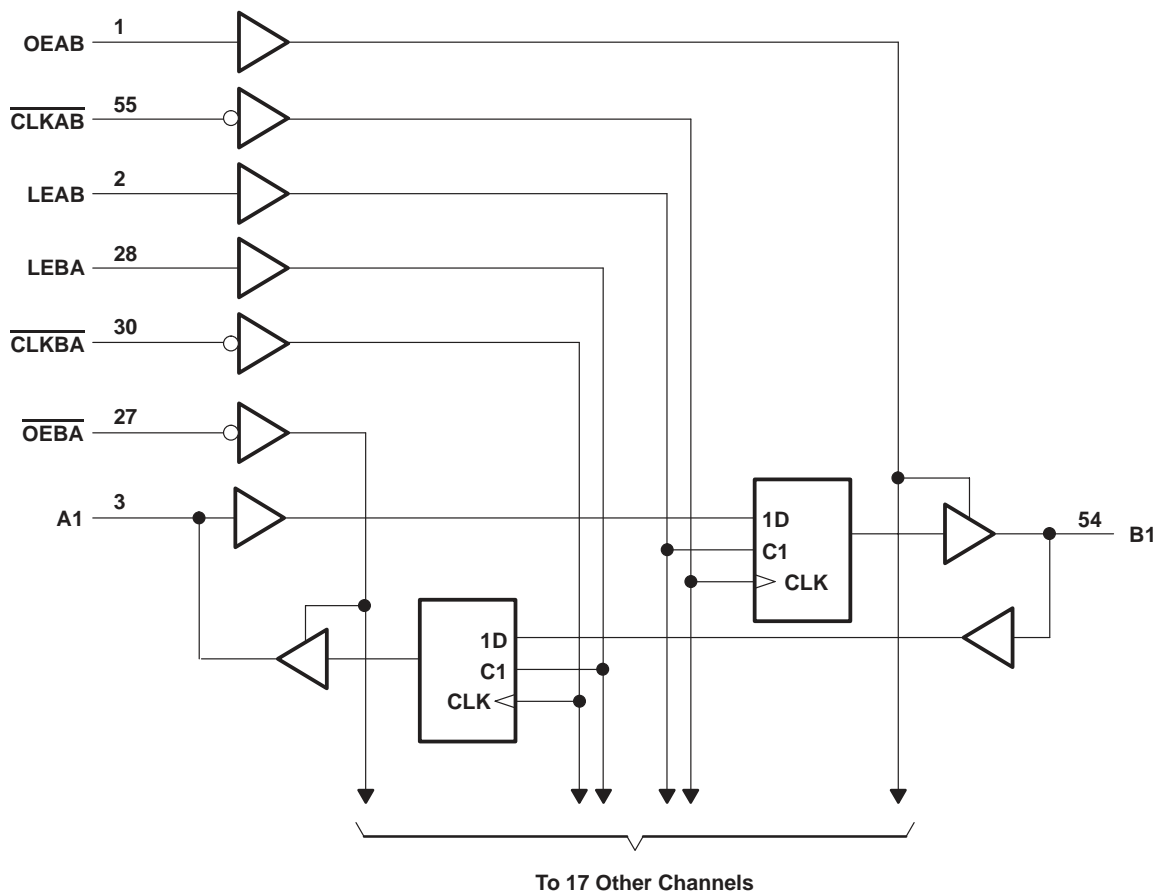
| INPUTS |      |       |   | OUTPUT<br>B      |
|--------|------|-------|---|------------------|
| OEAB   | LEAB | CLKAB | A |                  |
| L      | X    | X     | X | Z                |
| H      | H    | X     | L | L                |
| H      | H    | X     | H | H                |
| H      | L    | ↓     | L | L                |
| H      | L    | ↓     | H | H                |
| H      | L    | H     | X | B <sub>0</sub> ‡ |
| H      | L    | L     | X | B <sub>0</sub> § |

† A-to-B data flow is shown; B-to-A flow is similar, but uses OEBA, LEBA, and CLKBA.

‡ Output level before the indicated steady-state input conditions were established

§ Output level before the indicated steady-state input conditions were established, provided that CLKAB was low before LEAB went low

### logic diagram (positive logic)



Pin numbers shown are for the DGG, DL, and WD packages.

# SN54LVTH16500, SN74LVTH16500

## 3.3-V ABT 18-BIT UNIVERSAL BUS TRANSCEIVERS

### WITH 3-STATE OUTPUTS

SCBS701F – JULY 1997 – REVISED SEPTEMBER 2003

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

|  |                            |
|--|----------------------------|
| Supply voltage range, $V_{CC}$   | -0.5 V to 4.6 V            |
| Input voltage range, $V_I$ (see Note 1)  | -0.5 V to 7 V              |
| Voltage range applied to any output in the high-impedance or power-off state, $V_O$ (see Note 1) | -0.5 V to 7 V              |
| Voltage range applied to any output in the high state, $V_O$ (see Note 1)                        | -0.5 V to $V_{CC} + 0.5$ V |
| Current into any output in the low state, $I_O$ : SN54LVTH16500                                  | 96 mA                      |
| SN74LVTH16500  | 128 mA                     |
| Current into any output in the high state, $I_O$ (see Note 2): SN54LVTH16500                     | 48 mA                      |
| SN74LVTH16500  | 64 mA                      |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )  | -50 mA                     |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ )   | -50 mA                     |
| Package thermal impedance, $\theta_{JA}$ (see Note 3): DGG package                               | 64°C/W                     |
| DL package   | 56°C/W                     |
| GQL/ZQL package  | 42°C/W                     |
| Storage temperature range, $T_{stg}$   | -65°C to 150°C             |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
 2. This current flows only when the output is in the high state and  $V_O > V_{CC}$ .  
 3. The package thermal impedance is calculated in accordance with JESD 51-7.

#### recommended operating conditions (see Note 4)

|  | SN54LVTH16500   |     | SN74LVTH16500 |     | UNIT      |
|--|-----------------|-----|---------------|-----|-----------|
|  | MIN             | MAX | MIN           | MAX |           |
| $V_{CC}$ Supply voltage                                | 2.7             | 3.6 | 2.7           | 3.6 | V         |
| $V_{IH}$ High-level input voltage                      | 2               |     | 2             |     | V         |
| $V_{IL}$ Low-level input voltage                       |                 | 0.8 |               | 0.8 | V         |
| $V_I$ Input voltage                                    |                 | 5.5 |               | 5.5 | V         |
| $I_{OH}$ High-level output current                     |                 | -24 |               | -32 | mA        |
| $I_{OL}$ Low-level output current                      |                 | 48  |               | 64  | mA        |
| $\Delta t/\Delta v$ Input transition rise or fall rate | Outputs enabled |     |               | 10  | ns/V      |
| $\Delta t/\Delta V_{CC}$ Power-up ramp rate            | 200             |     | 200           |     | $\mu$ s/V |
| $T_A$ Operating free-air temperature                   | -55             | 125 | -40           | 85  | °C        |

NOTE 4: All unused control inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

# SN54LVTH16500, SN74LVTH16500 3.3-V ABT 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS701F – JULY 1997 – REVISED SEPTEMBER 2003

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER          |  | TEST CONDITIONS  | SN54LVTH16500   |                      | SN74LVTH16500 |           | UNIT          |      |
|--------------------|--|--|---|----------------------|---------------|-----------|---------------|------|
|                    |  |  | MIN   | TYP†                 | MAX           | MIN       |               | TYP† |
| $V_{IK}$           |  | $V_{CC} = 2.7\text{ V}$ ,<br>$I_I = -18\text{ mA}$   | -1.2  |                      | -1.2          |           | V             |      |
| $V_{OH}$           |  | $V_{CC} = 2.7\text{ V to }3.6\text{ V}$ ,<br>$I_{OH} = -100\text{ }\mu\text{A}$  | $V_{CC}-0.2$  |                      | $V_{CC}-0.2$  |           | V             |      |
|                    |  | $V_{CC} = 2.7\text{ V}$ ,<br>$I_{OH} = -8\text{ mA}$   | 2.4   |                      | 2.4           |           |               |      |
|                    |  | $V_{CC} = 3\text{ V}$  | 2   |                      | 2             |           |               |      |
| $V_{OL}$           |  | $V_{CC} = 2.7\text{ V}$  | $I_{OL} = 100\text{ }\mu\text{A}$                             |                      | 0.2           |           | V             |      |
|                    |  |  | $I_{OL} = 24\text{ mA}$                                       |                      | 0.5           |           |               |      |
|                    |  | $V_{CC} = 3\text{ V}$  | $I_{OL} = 16\text{ mA}$                                       |                      | 0.4           |           |               |      |
|                    |  |  | $I_{OL} = 32\text{ mA}$                                       |                      | 0.5           |           |               |      |
|                    |  |  | $I_{OL} = 48\text{ mA}$                                       |                      | 0.55          |           |               |      |
|                    |  |  | $I_{OL} = 64\text{ mA}$                                       |                      | 0.55          |           |               |      |
| $I_I$              |  | Control inputs   | $V_{CC} = 3.6\text{ V}$ ,<br>$V_I = V_{CC}\text{ or GND}$     |                      | $\pm 1$       |           | $\mu\text{A}$ |      |
|                    |  |  | $V_{CC} = 0\text{ or }3.6\text{ V}$ ,<br>$V_I = 5.5\text{ V}$ |                      | 10            |           |               |      |
|                    |  | A or B ports‡  | $V_{CC} = 3.6\text{ V}$                                       | $V_I = 5.5\text{ V}$ |               | 20        |               |      |
|                    |  |  |   | $V_I = V_{CC}$       |               | 1         |               |      |
|                    |  | $V_I = 0$  |   | -5                   |               |           |               |      |
| $I_{off}$          |  | $V_{CC} = 0$ ,<br>$V_I\text{ or }V_O = 0\text{ to }4.5\text{ V}$   |   |                      | $\pm 100$     |           | $\mu\text{A}$ |      |
| $I_I(\text{hold})$ |  | A or B ports   | $V_{CC} = 3\text{ V}$ ,<br>$V_I = 0.8\text{ V}$               |                      | 75            |           | $\mu\text{A}$ |      |
|                    |  |  | $V_I = 2\text{ V}$  |                      | -75           |           |               |      |
|                    |  | $V_{CC} = 3.6\text{ V}\S$ ,<br>$V_I = 0\text{ to }3.6\text{ V}$  |   |                      |               | $\pm 500$ |               |      |
| $I_{OZPU}$         |  | $V_{CC} = 0\text{ to }1.5\text{ V}$ ,<br>$V_O = 0.5\text{ V to }3\text{ V}$ ,<br>$\overline{OE}/\overline{OE} = \text{don't care}$ | $\pm 100^*$   |                      | $\pm 100$     |           | $\mu\text{A}$ |      |
| $I_{OZPD}$         |  | $V_{CC} = 1.5\text{ V to }0$ ,<br>$V_O = 0.5\text{ V to }3\text{ V}$ ,<br>$\overline{OE}/\overline{OE} = \text{don't care}$        | $\pm 100^*$   |                      | $\pm 100$     |           | $\mu\text{A}$ |      |
| $I_{CC}$           |  | $V_{CC} = 3.6\text{ V}$ ,<br>$I_O = 0$ ,<br>$V_I = V_{CC}\text{ or GND}$   | Outputs high  |                      | 0.19          |           | mA            |      |
|                    |  |  | Outputs low   |                      | 5             |           |               |      |
|                    |  |  | Outputs disabled  |                      | 0.19          |           |               |      |
| $\Delta I_{CC}\P$  |  | $V_{CC} = 3\text{ V to }3.6\text{ V}$ , One input at $V_{CC} - 0.6\text{ V}$ ,<br>Other inputs at $V_{CC}\text{ or GND}$           | 0.2   |                      | 0.2           |           | mA            |      |
| $C_i$              |  | $V_I = 3\text{ V or }0$  | 4   |                      | 4             |           | pF            |      |
| $C_{iO}$           |  | $V_O = 3\text{ V or }0$  | 10  |                      | 10            |           | pF            |      |

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

† All typical values are at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ Unused pins at  $V_{CC}\text{ or GND}$

§ This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level, rather than  $V_{CC}\text{ or GND}$ .

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.



# SN54LVTH16500, SN74LVTH16500 3.3-V ABT 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS701F – JULY 1997 – REVISED SEPTEMBER 2003

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

|                    |                 | SN54LVTH16500                                  |                              |                         |     | SN74LVTH16500                            |     |                         |     | UNIT |  |
|--------------------|-----------------|--|------------------------------|-------------------------|-----|--|-----|-------------------------|-----|------|--|
|                    |                 | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$       |                              | $V_{CC} = 2.7\text{ V}$ |     | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ |     | $V_{CC} = 2.7\text{ V}$ |     |      |  |
|                    |                 | MIN  | MAX                          | MIN                     | MAX | MIN                                      | MAX | MIN                     | MAX |      |  |
| $f_{\text{clock}}$ | Clock frequency | 150  |                              | 150                     |     | 150                                      |     | 150                     |     | MHz  |  |
| $t_w$              | Pulse duration  | LE high  |                              | 3.3                     |     | 3.3                                      |     | 3.3                     |     | ns   |  |
|                    |                 | $\overline{\text{CLK}}$ high or low            |                              | 3.3                     |     | 3.3                                      |     | 3.3                     |     |      |  |
| $t_{\text{su}}$    | Setup time      | A before $\overline{\text{CLKAB}}\downarrow$   |                              | 3.1                     |     | 3.1                                      |     | 2.9                     |     | ns   |  |
|                    |                 | B before $\overline{\text{CLKBA}}\downarrow$   |                              | 3.1                     |     | 3.1                                      |     | 2.9                     |     |      |  |
|                    |                 | A or B before LE $\downarrow$                  | $\overline{\text{CLK}}$ high |                         | 1.5 |  | 0.6 |                         | 1.4 |      |  |
|                    |                 |  | $\overline{\text{CLK}}$ low  |                         | 3.1 |  | 2.5 |                         | 2.9 |      |  |
| $t_h$              | Hold time       | A or B after $\overline{\text{CLK}}\downarrow$ |                              | 0.4                     |     | 0.4                                      |     | 0.4                     |     | ns   |  |
|                    |                 | A or B after LE $\downarrow$                   |                              | 1.7                     |     | 1.7                                      |     | 1.6                     |     |      |  |

switching characteristics over recommended operating free-air temperature range,  $C_L = 50\text{ pF}$  (unless otherwise noted) (see Figure 1)

| PARAMETER        | FROM (INPUT)   | TO (OUTPUT) | SN54LVTH16500                            |     |                         |     | SN74LVTH16500                            |      |     |                         | UNIT |
|------------------|--|-------------|--|-----|-------------------------|-----|--|------|-----|-------------------------|------|
|                  |  |             | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ |     | $V_{CC} = 2.7\text{ V}$ |     | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ |      |     | $V_{CC} = 2.7\text{ V}$ |      |
|                  |  |             | MIN                                      | MAX | MIN                     | MAX | MIN                                      | TYP† | MAX | MIN                     |      |
| $f_{\text{max}}$ |  |             | 150                                      |     | 150                     |     | 150                                      |      |     | 150                     | MHz  |
| $t_{\text{PLH}}$ | B or A   | A or B      | 1.2 3.9                                  |     | 4.1                     |     | 1.3 2.8 3.7                              |      |     | 4                       | ns   |
| $t_{\text{PHL}}$ |  |             | 1.2 3.9                                  |     | 4.1                     |     | 1.3 2.6 3.7                              |      |     | 4                       |      |
| $t_{\text{PLH}}$ | LEBA or LEAB   | A or B      | 1.4 5.5                                  |     | 5.9                     |     | 1.5 3.8 5.1                              |      |     | 5.7                     | ns   |
| $t_{\text{PHL}}$ |  |             | 1.4 5.5                                  |     | 5.9                     |     | 1.5 3.8 5.1                              |      |     | 5.7                     |      |
| $t_{\text{PLH}}$ | $\overline{\text{CLKBA}}$ or $\overline{\text{CLKAB}}$ | A or B      | 1.2 5.3                                  |     | 6.1                     |     | 1.3 3.6 5                                |      |     | 5.9                     | ns   |
| $t_{\text{PHL}}$ |  |             | 1.2 5.3                                  |     | 6.1                     |     | 1.3 3.5 5                                |      |     | 5.9                     |      |
| $t_{\text{PZH}}$ | $\overline{\text{OEBA}}$ or OEAB                       | A or B      | 1.2 5.1                                  |     | 5.8                     |     | 1.3 3.6 4.8                              |      |     | 5.5                     | ns   |
| $t_{\text{PZL}}$ |  |             | 1.2 5.1                                  |     | 5.8                     |     | 1.3 3.6 4.8                              |      |     | 5.5                     |      |
| $t_{\text{PHZ}}$ | $\overline{\text{OEBA}}$ or OEAB                       | A or B      | 1.6 6.1                                  |     | 6.6                     |     | 1.7 4.5 5.8                              |      |     | 6.3                     | ns   |
| $t_{\text{PLZ}}$ |  |             | 1.6 6.1                                  |     | 6.6                     |     | 1.7 4.1 5.8                              |      |     | 6.3                     |      |

† All typical values are at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

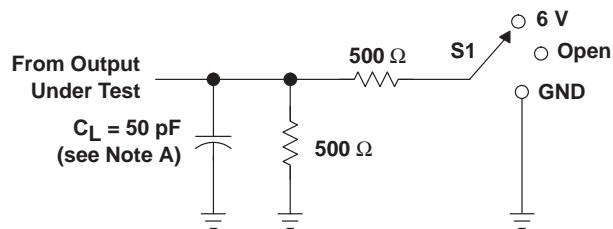
PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.



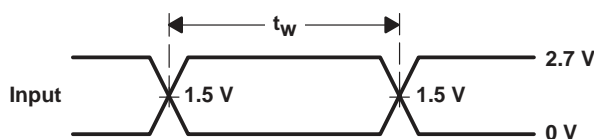
# SN54LVTH16500, SN74LVTH16500 3.3-V ABT 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS701F – JULY 1997 – REVISED SEPTEMBER 2003

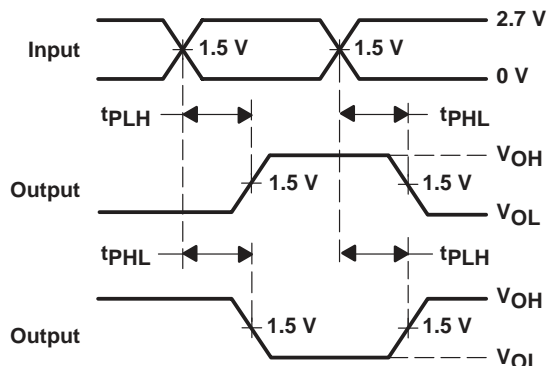
## PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT

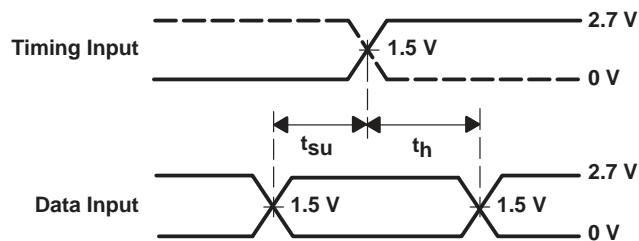


VOLTAGE WAVEFORMS  
PULSE DURATION

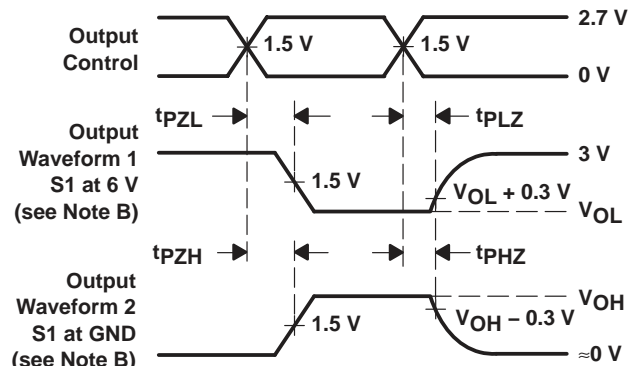


VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS

| TEST              | S1   |
|-------------------|------|
| $t_{PHL}/t_{PLH}$ | Open |
| $t_{PLZ}/t_{PZL}$ | 6 V  |
| $t_{PHZ}/t_{PZH}$ | GND  |



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .  
 D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

| Orderable Device  | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|-------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| SN74LVTH16500DGGR | ACTIVE        | TSSOP        | DGG             | 56   | 2000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | LVTH16500               | <a href="#">Samples</a> |
| SN74LVTH16500DL   | ACTIVE        | SSOP         | DL              | 56   | 20          | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 85    | LVTH16500               | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:**The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.





**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74LVTH16500DGGR | TSSOP        | DGG             | 56   | 2000 | 330.0              | 24.4               | 8.6     | 15.6    | 1.8     | 12.0    | 24.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LVTH16500DGGR | TSSOP        | DGG             | 56   | 2000 | 367.0       | 367.0      | 45.0        |

**TUBE**

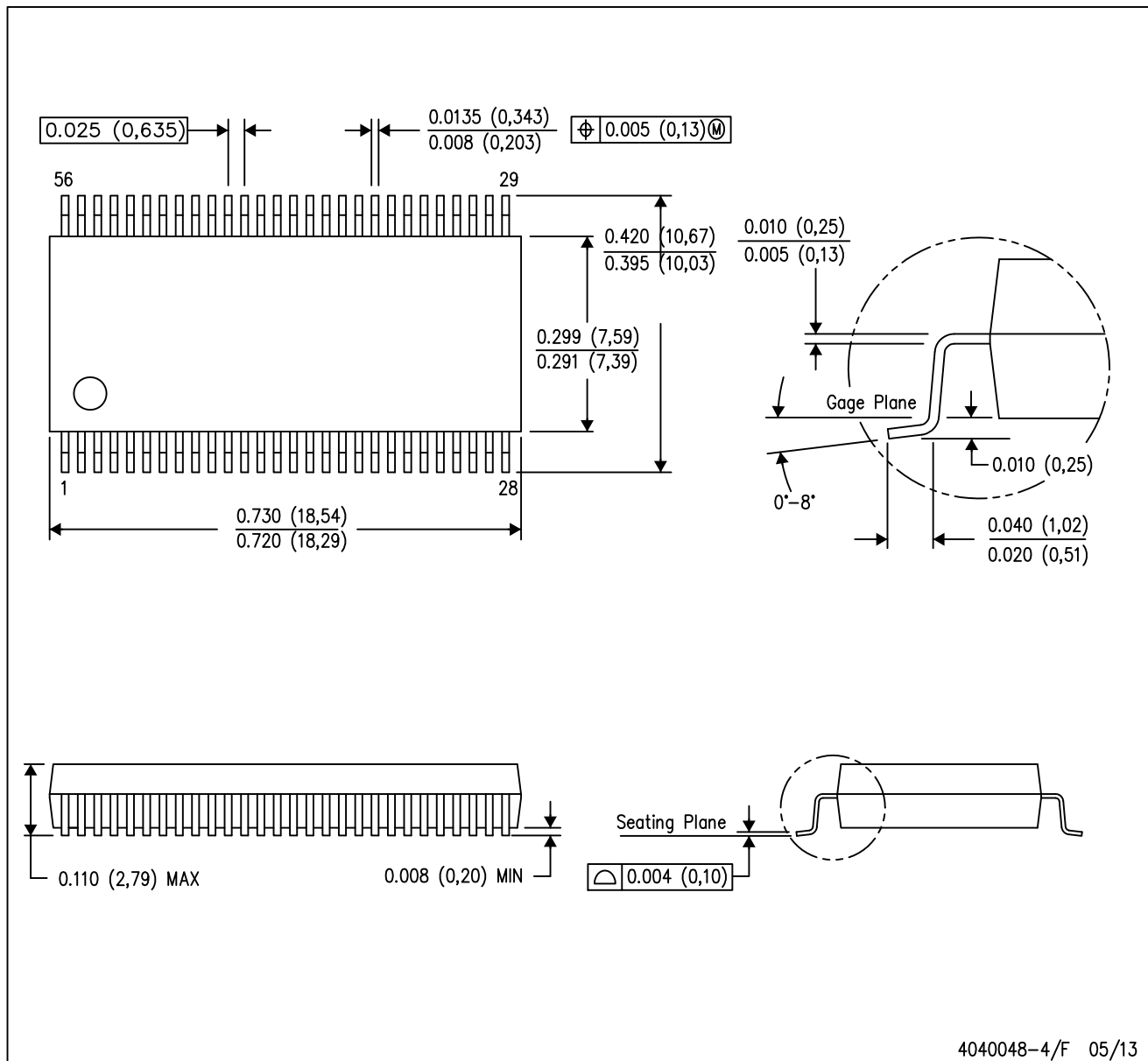

\*All dimensions are nominal

| Device          | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN74LVTH16500DL | DL           | SSOP         | 56   | 20  | 473.7  | 14.24  | 5110   | 7.87   |

# MECHANICAL DATA

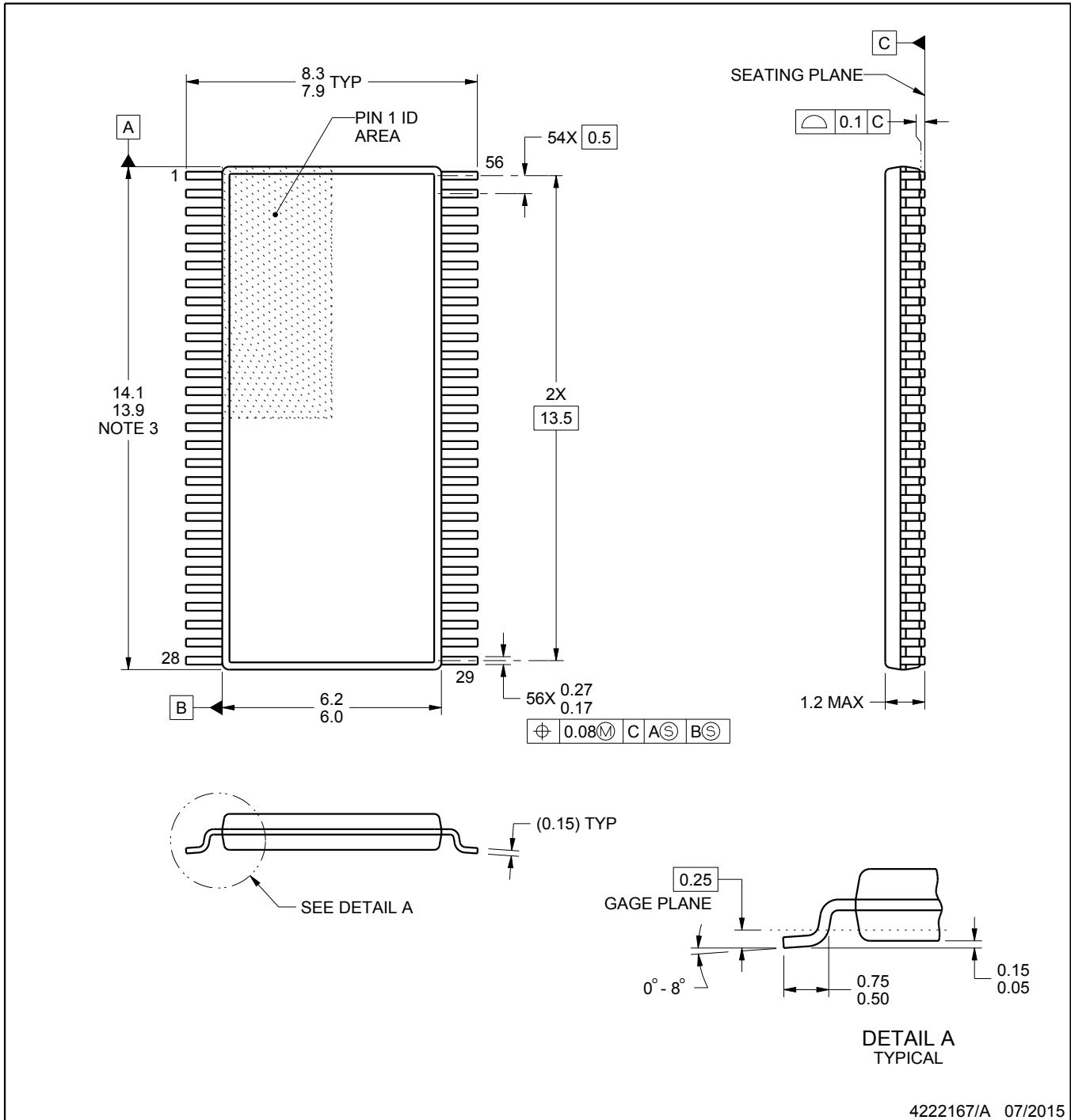
DL (R-PDSO-G56)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MO-118

PowerPAD is a trademark of Texas Instruments.



4222167/A 07/2015

NOTES:

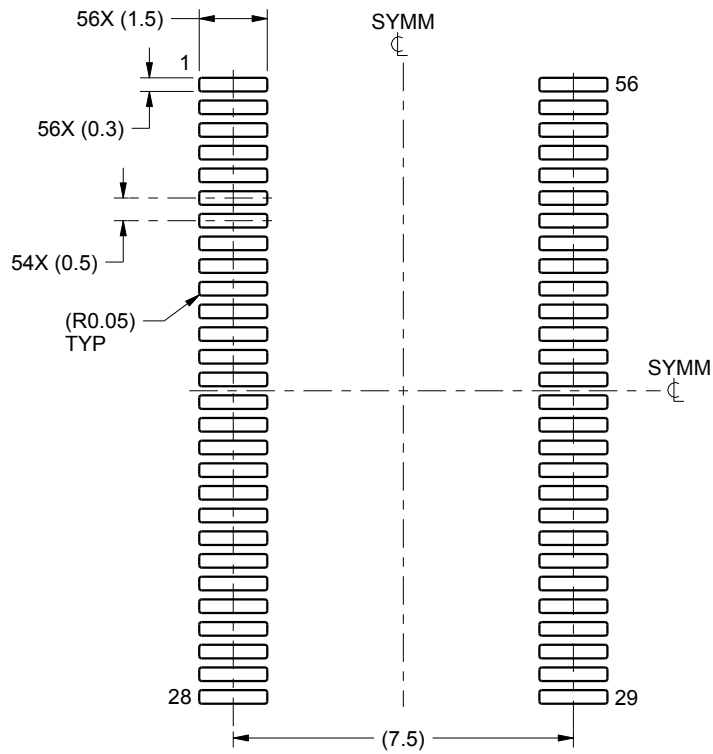
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

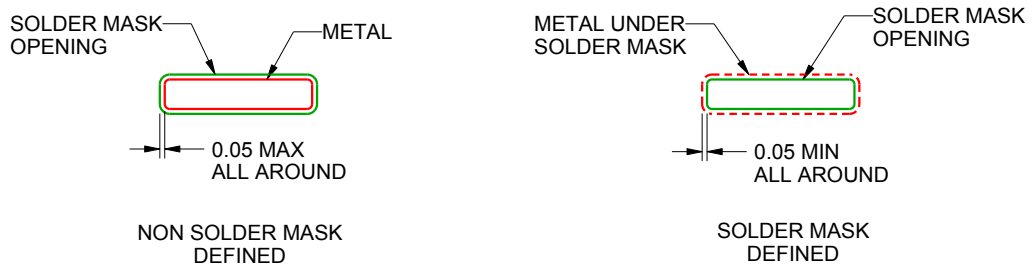
DGG0056A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

4222167/A 07/2015

NOTES: (continued)

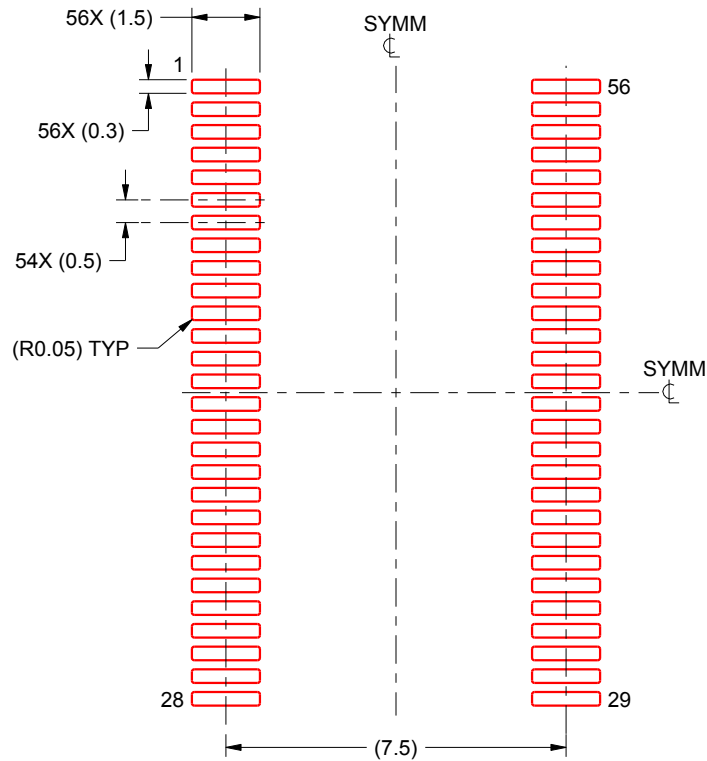
- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DGG0056A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

4222167/A 07/2015

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.



## IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](http://ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2022, Texas Instruments Incorporated